

TOSHIBA Diode Silicon Epitaxial Planar Type

1SS187

Ultra High Speed Switching Application

AEC-Q101 Qualified (Note1)

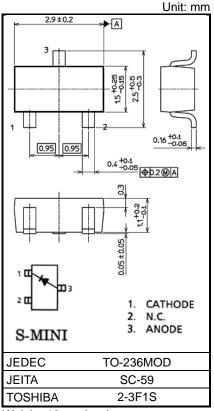
• Small package : SC-59

• Low forward voltage $: V_{F(3)} = 0.92 \text{ V (typ.)}$ • Fast reverse recovery time: $t_{rr} = 1.6 \text{ ns (typ.)}$ • Small total capacitance $: C_{T} = 2.2 \text{ pF (typ.)}$

Note1: For detail information, please contact our sales.

Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V _{RM}	85	V
Reverse voltage	V _R	80	V
Maximum (peak) forward current	IFM	300	mA
Average forward current	lo	100	mA
Surge current (10ms)	IFSM	2	А
Power dissipation	P _D (Note 2, 4)	200	mW
	P _D (Note 3)	150	
Junction temperature	T _j (Note 2)	150	°C
	T _j (Note 3)	125	
Storage temperature	T _{stg} (Note 2)	-55 to 150	°C
	T _{stg} (Note 3)	-55 to 125	



Weight: 12 mg (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 2: For devices with the ordering part number ending in LF(T.
- Note 3: For devices with the ordering part number in other than LF(T.
- Note 4: Mounted on a FR4 board. (25.4 mm \times 25.4 mm \times 1.6 mm, Cu pad: 0.8 mm² \times 3)

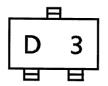
Start of commercial production 1982-06



Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур	Max	Unit
Forward voltage	VF (1)	I _F =1 mA	_	0.61	_	٧
	VF (2)	I _F = 10 mA	_	0.74	_	
	V _F (3)	I _F = 100 mA	_	0.92	1.20	
Reverse current -	IR (1)	V _R = 30 V	_	_	0.1	μА
	IR (2)	V _R = 80 V	_	_	0.5	
Total capacitance	Ст	V _R = 0 V, f = 1 MHz	_	2.2	4.0	pF
Reverse recovery tme	t _{rr}	I _F = 10 mA (Fig.1)	_	1.6	4.0	ns

Marking



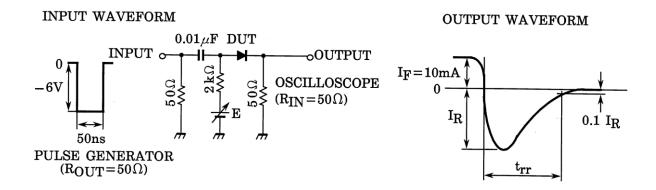
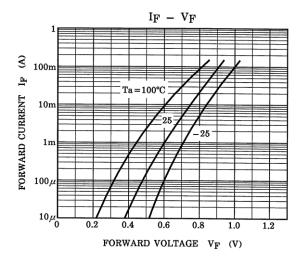
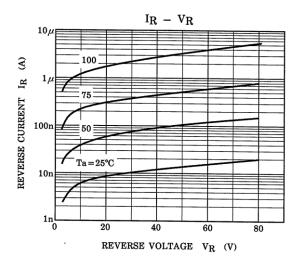


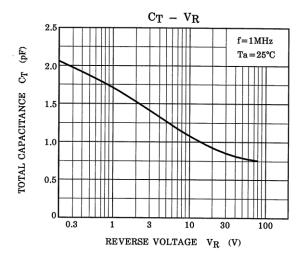
Fig.1 Reverse recovery time (t_{rr}) test circuit

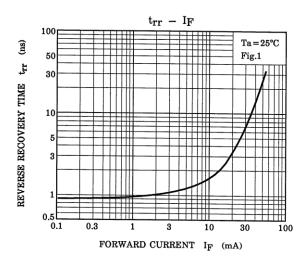


Characteristics Curves









The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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